

42390.P6623



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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

#13/Response
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In re Application of:

Ma, et al.

Serial No.: 09/374,502

Filed: August 13, 1999

For: ISOLATION STRUCTURE
CONFIGURATIONS FOR
MODIFYING STRESSES IN
SEMICONDUCTOR DEVICES

Examiner: J. Fenty

Group Art Unit: 2815

Attorney Docket No.: 42390.P6623

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RESPONSE

Hon. Assistant Commissioner for Patents
Washington, D.C. 20231

Sir:

In response to the Office Action mailed September 17, 2001 with the time for response having been extended by one month, Applicants respectfully request that the Examiner consider the following remarks: